

APPROVAL SHEET

Part No:

BF5H06H-YIR-050mA

NOTE :

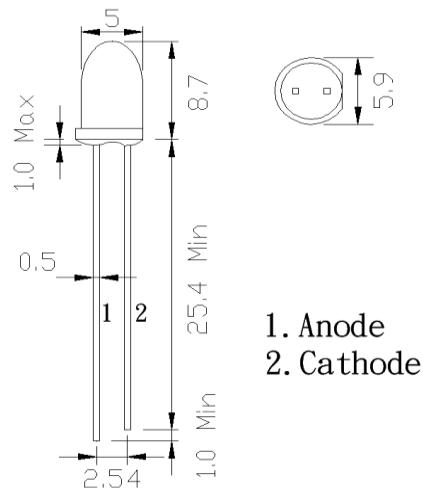
Green Part

MAKER			CUSTOMER	
 SOLIDLITE				
R&D	QA	Sales	Checked	Approved
				

Prepared	Checked	Approved
Rachel Lee	Sky Lin	Kenneth Wu

DESCRIPTION:

Device Type : BF5H06H-YIR-050mA
 Dice Material : AlGaAs
 Light Color : InfraRed 850nm
 Lens Color : Black
 Lens Dimension : 5 mm



All epoxy resin dimension are in millimeter
tolerance is $\pm 0.2\text{mm}$

Absolute Maximum Ratings at Ta=25°C

Parameter	Max.	Unit
DC Forward Current	100	mA
Reverse Voltage	5	V
Power Dissipation	150	mW
Operating Temperature	Topr : -40 ~ +80	°C
Storage Temperature	Tstr : -40 ~ +100	°C
Solder DIP (MAX. 5 seconds, 1.6mm from body) Temperature	260°C	

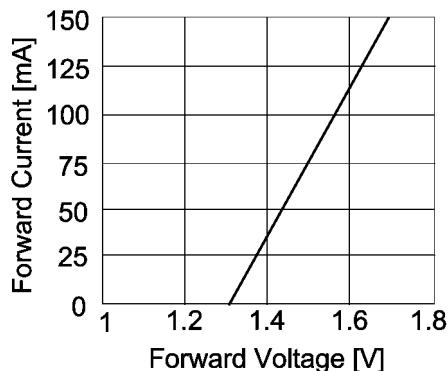
Electrical and Optical Characteristics at Ta=25°C

Symbol	Description	Test Condition	Min.	Typ.	Max.	Unit
V _F	Forward Voltage	I _F = 50mA		1.4	2.0	V
I _R	Reverse Current	V _R = 5V	-	-	10	μA
λ _P	Peak Emission Wavelength	I _F = 50mA	-	850	-	nm
Δλ	Spectral Line Halfwidth	I _F = 50mA	-	40	-	nm
2θ _{1/2}	Viewing Angle	I _F = 50mA	-	6	-	Deg.
P _O	Radiant Power	I _F = 50mA	170	250	-	mW

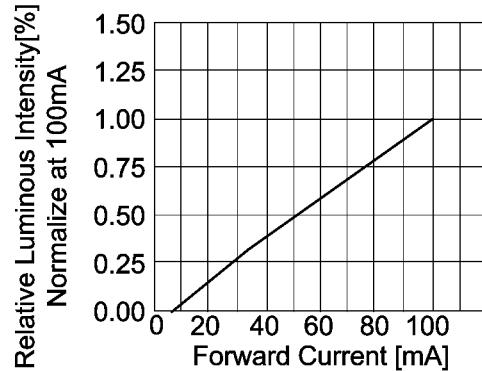
- Note:
- The lead should be formed up to 5mm from the body of device without forming stress.
 - Soldering shall be performed after lead forming.
 - All dimensions are in millimeters

LED LAMP Technical Data

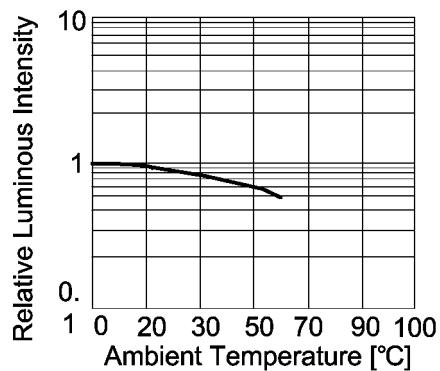
Typical Optical-Electrical Characteristic Curves



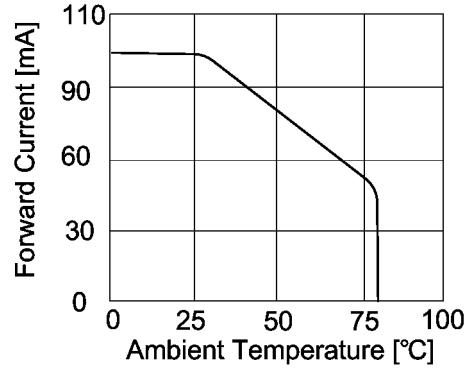
**Forward Current
Vs. Forward Voltage**



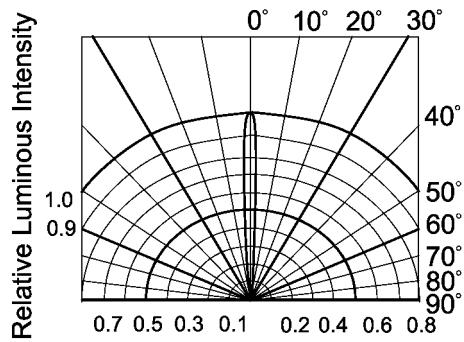
**Luminous Intensity
Vs. Forward Current**



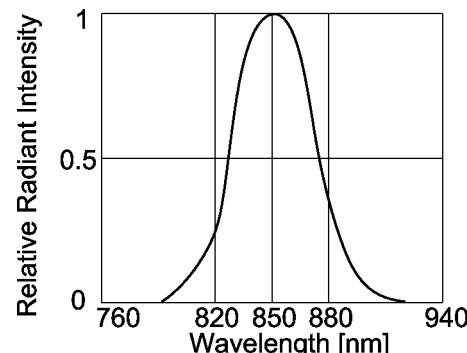
**Luminous Intensity
Vs. Ambient Temperature**



**Forward Current
Vs. Ambient Temperature**



Radiation Pattern



**Relative Luminous Intensity
Vs. Wavelength**